

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP1520K uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

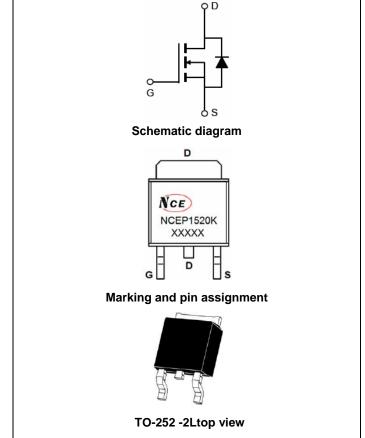
General Features

- V_{DS} =150V,I_D =20A
 - $R_{DS(ON)}$ =59m Ω (typical) @ V_{GS}=10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- LED backlighting
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP1520K	NCEP1520K	TO-252-2L	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	20	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	14	А
Pulsed Drain Current	I _{DM}	80	A
Maximum Power Dissipation	PD	68	W
Derating factor		0.45	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	65	mJ
Drain Source voltage slope, V⊳s ≤120 V,	dv/dt	50	V/ns
Drain Source voltage slope, V₀s ≤120 V, Is₀ <i₀< td=""><td>dv/dt</td><td>50</td><td>V/ns</td></i₀<>	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C



Thermal Characteristic

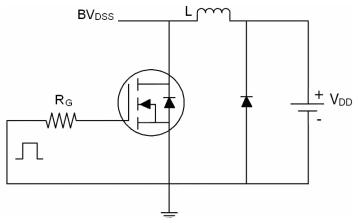
Thermal Résistance, Junction-to-Case ^{(Note}	R _{θJC}	2.2		0	°C/W	
Electrical Characteristics (T _A =	=25℃unless of	therwise noted)				
Parameter	Symbol	Condition	Min	Тур	Мах	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	150	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	· ·					•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	3.3	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I _D =10A	-	59	65	mΩ
Gate resistance	R _G		-	4.5	-	Ω
Forward Transconductance	g fs	V _{DS} =5V,I _D =10A	15	-	-	S
Dynamic Characteristics (Note4)	· ·					•
Input Capacitance	C _{lss}	V _{DS} =75V,V _{GS} =0V, F=1.0MHz	-	600		PF
Output Capacitance	C _{oss}		-	74.7		PF
Reverse Transfer Capacitance	C _{rss}		-	10.8		PF
Switching Characteristics (Note 4)	· ·					•
Turn-on Delay Time	t _{d(on)}		-	9.5	-	nS
Turn-on Rise Time	tr	V_{DD} =75V, RL=7.5 Ω	-	5.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =3 Ω	-	12.5	-	nS
Turn-Off Fall Time	t _f		-	3	-	nS
Total Gate Charge	Qg		-	12	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =75V,I _D =10A, V _{GS} =10V	-	5.7	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	2.7	-	nC
Drain-Source Diode Characteristics	· ·					•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	20	Α
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-	29	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	130	-	nC

Notes:

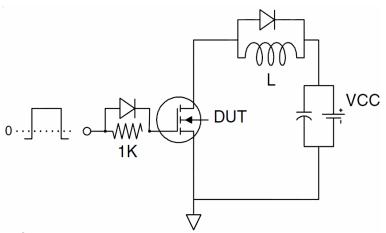
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t \leq 10 sec.
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ \! \mathrm{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω



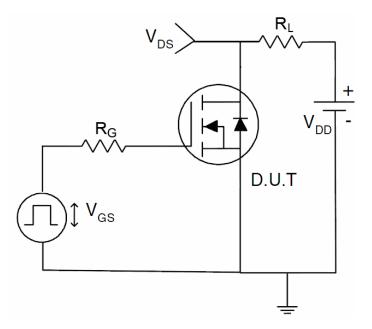
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





100

125

9

12

25℃

0.8

1.0

1.2

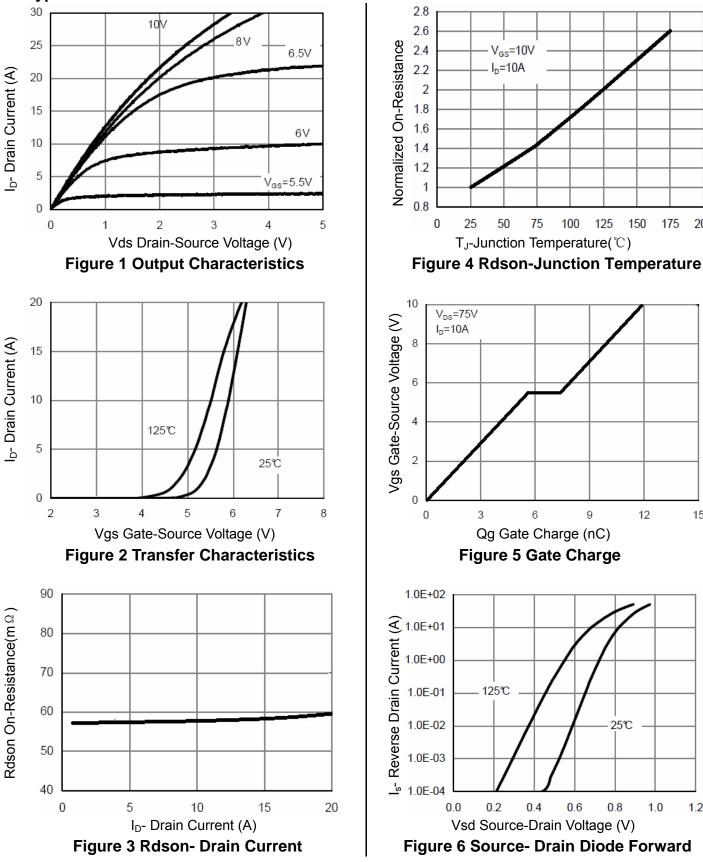
0.6

15

150

175

200



Typical Electrical and Thermal Characteristics



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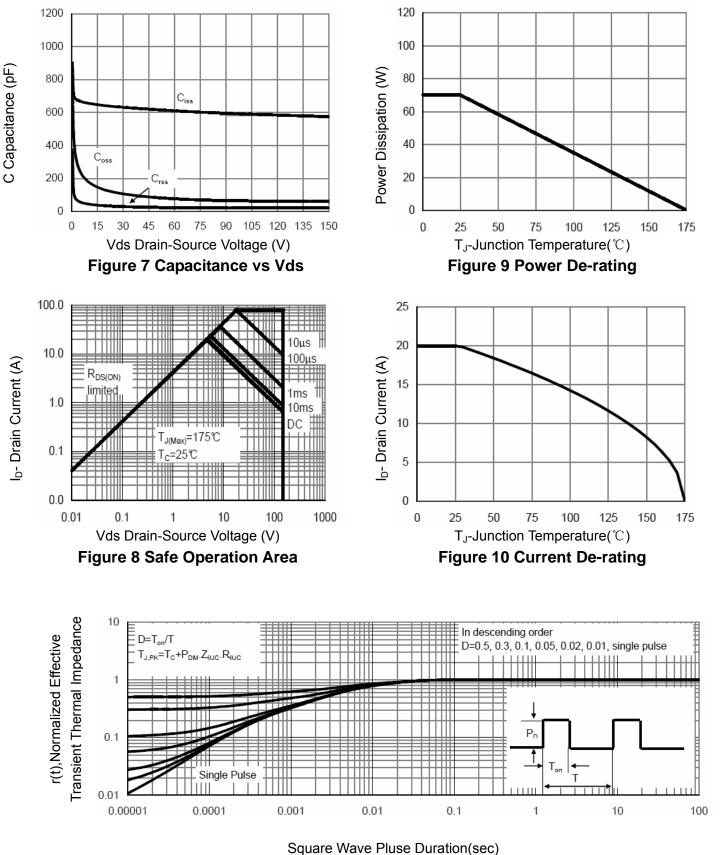
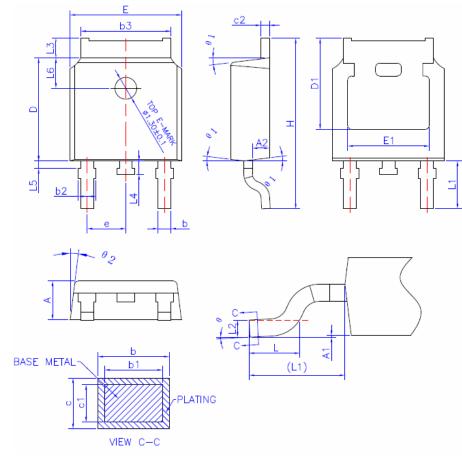


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252-2L Package Information



(UNIT:	S OF MEAS	JRE =MILLI	METER)	
SYMBOL	MIN	NOM	MAX	
A	2.20	2.30	2.38	
A1	0	—	0.10	
A2	0.90	1.01	1,10	
b	0.72	—	0.85	
b1	0.71	0.76	0.81	
b2	0.72	—	0,90	
b3	5.13	5.33	5.46	
с	0,47	—	0,60	
c1	0.46	0.51	0,56	
c2	0.47	—	0.60	
D	6.00	6,10	6,20	
D1	5,25	—		
E	6.50	6.60	6.70	
E1	4.70	—	—	
е	2,186	2,286	2,386	
Н	9.80	10.10	10.40	
L	1,40	1,50	1,70	
L1	2.90 REF			
L2	0.508 BSC			
L3	0,90	—	1,25	
L4	0.60	0.80	1.00	
L5	0.15	—	0.75	
L6	1.80 REF			
θ	0°	—	8°	
θ1	5°	7°	9°	
θ2	5°	7°	9°	
'ES:				

COMMON DIMENSIONS

NOTES: ALL DIMENSIONS REFER TO JEDEC STANDARED TO-252 AA DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS



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